

## DESCRIPTION:

With high ability to withstand the shock loading of large current, BTW69-1200 series of silicon controlled rectifiers provide high dv/dt rate with strong resistance to electromagnetic interference. They are especially recommended for use on solid state relay, motorcycle, power charger, T-tools etc.



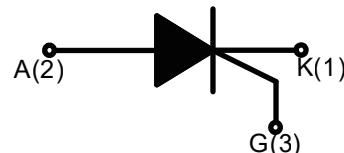
TO-247



TO-3P

## MAIN FEATURES

Symbol	Value	Symbol
$V_{DRM}/ V_{RRM}$	1000/1200	V
$I_{T(RMS)}$	55	A
$I_{GT}$	$\leq 50$	mA



## ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Storage junction temperature range	$T_{stg}$	-40-150	°C
Operating junction temperature range	$T_j$	-40-125	°C
Repetitive peak off-state voltage( $T_j=25^\circ\text{C}$ )	$V_{DRM}$	1000/1200	V
Repetitive peak reverse voltage( $T_j=25^\circ\text{C}$ )	$V_{RRM}$	1000/1200	V
Non repetitive peak off-state voltage	$V_{DSM}$	$V_{DRM} + 100$	V
Non repetitive peak reverse voltage	$V_{RSM}$	$V_{RRM} + 100$	V
RMS on-state current	TO-3P Ins ( $T_c=70^\circ\text{C}$ )	55	A
	TO-247S /TO-247 ( $T_c=75^\circ\text{C}$ )		
	TG-C ( $T_c=73^\circ\text{C}$ )		

Non repetitive surge peak on-state current (tp=10ms)	I <sub>TSM</sub>	520	A
I <sup>2</sup> t value for fusing (tp=10ms)	I <sup>2</sup> t	1350	A <sup>2</sup> s
Critical rate of rise of on-state current (I <sub>G</sub> =2×I <sub>GT</sub> )	dI/dt	150	A/μs
Peak gate current	I <sub>GM</sub>	5	A
Average gate power dissipation	P <sub>G(AV)</sub>	1	W
Peak gate power	P <sub>GM</sub>	10	W

### ELECTRICAL CHARACTERISTICS (T<sub>j</sub>=25°C unless otherwise specified)

Symbol	Test Condition	Value			Unit
		MIN.	TYP.	MAX.	
I <sub>GT</sub>	V <sub>D</sub> =12V R <sub>L</sub> =33Ω	-	-	50	mA
V <sub>GT</sub>		-	-	1.5	V
V <sub>GD</sub>	V <sub>D</sub> =V <sub>DRM</sub> T <sub>j</sub> =125°C R <sub>L</sub> =3.3KΩ	0.2	-	-	V
I <sub>L</sub>	I <sub>G</sub> =1.2I <sub>GT</sub>	-	-	150	mA
I <sub>H</sub>	I <sub>T</sub> =500mA	-	-	120	mA
dV/dt	V <sub>D</sub> =2/3V <sub>DRM</sub> Gate Open T <sub>j</sub> =125°C	800	-	-	V/μs

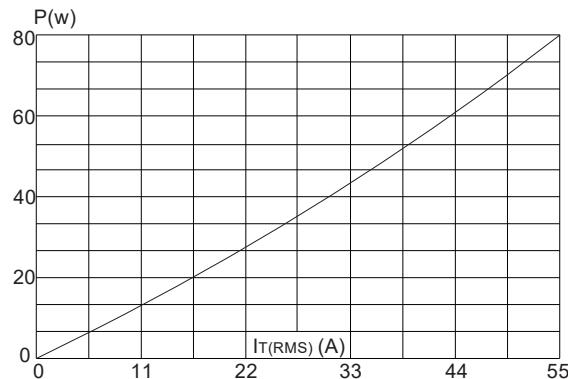
### STATIC CHARACTERISTICS

Symbol	Parameter		Value(MAX)	Unit
V <sub>TM</sub>	I <sub>TM</sub> =80A tp=380μs	T <sub>j</sub> =25°C	1.6	V
I <sub>DRM</sub>	V <sub>D</sub> =V <sub>DRM</sub> V <sub>R</sub> =V <sub>RRM</sub>	T <sub>j</sub> =25°C	10	μA
I <sub>RRM</sub>		T <sub>j</sub> =125°C	6	mA

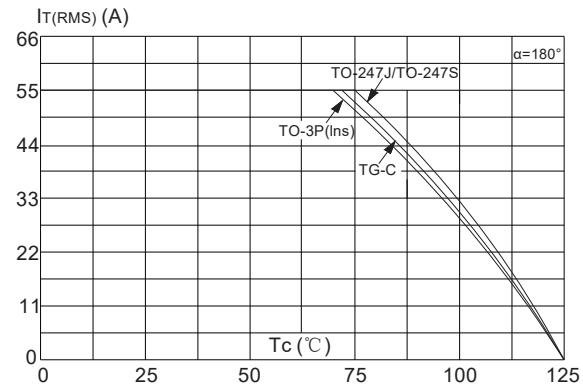
### THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
R <sub>th(j-c)</sub>	junction to case(AC)	TO-3P Ins	0.65	°C/W
		TO-247S/TO-247J	0.6	
		TG-C	0.63	

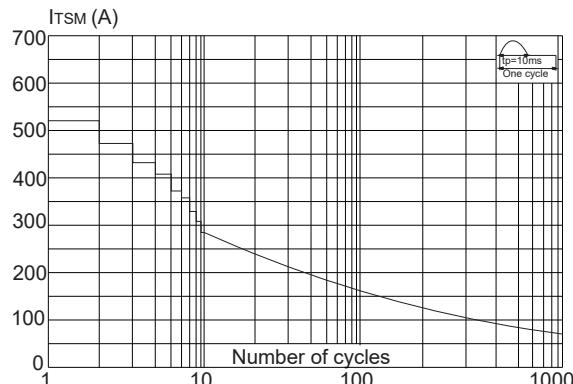
**FIG.1:** Maximum power dissipation versus RMS on-state current



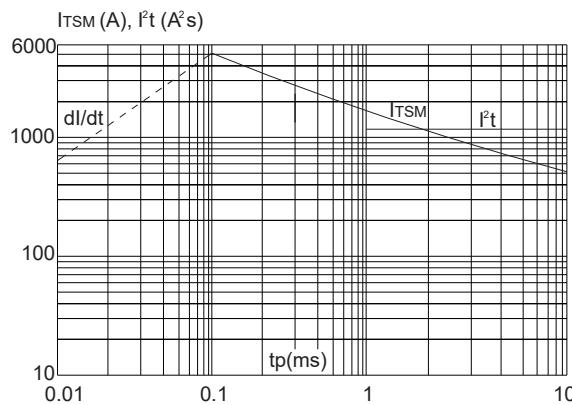
**FIG.2:** RMS on-state current versus case temperature



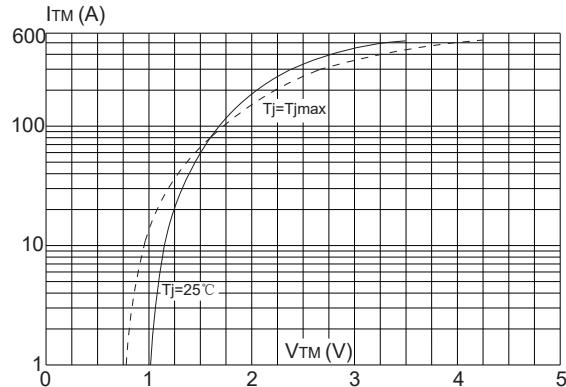
**FIG.3:** Surge peak on-state current versus number of cycles



**FIG.5:** Non-repetitive surge peak on-state current for a sinusoidal pulse with width  $tp < 10\text{ms}$ , and corresponding value of  $I^2t$  ( $dI/dt < 150\text{A}/\mu\text{s}$ )



**FIG.4:** On-state characteristics (maximum values)



**FIG.6:** Relative variations of gate trigger current, holding current and latching current versus junction temperature

